



## P-Channel Enhancement-Mode Vertical DMOS FETs

#### **Features**

- Free from secondary breakdown
- Low power drive requirement
- Ease of paralleling
- Low C<sub>ISS</sub> and fast switching speeds
- High input impedance and high gain
- Excellent thermal stability
- Integral source-to-drain diode

### **Applications**

- Motor controls
- Converters
- Amplifiers
- Switches
- Power supply circuits
- Drivers (relays, hammers, solenoids, lamps, memories, displays, bipolar transistors, etc.)

#### **General Description**

The Supertex VP0808 is an enhancement-mode (normallyoff) transistor that utilizes a vertical DMOS structure and Supertex's well-proven silicon-gate manufacturing process. This combination produces a device with the power handling capabilities of bipolar transistors, and the high input impedance and positive temperature coefficient inherent in MOS devices. Characteristic of all MOS structures, this device is free from thermal runaway and thermally-induced secondary breakdown.

Supertex's vertical DMOS FETs are ideally suited to a wide range of switching and amplifying applications where very low threshold voltage, high breakdown voltage, high input impedance, low input capacitance, and fast switching speeds are desired.

#### **Ordering Information**

Device	Device TO-92		R <sub>DS(ON)</sub> (max) (Ω)	l <sub>D(ON)</sub> (min) (A)	
VP0808	VP0808L-G	-80	5.0	-1.1	

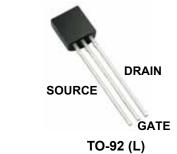
For packaged products, -G indicates package is RoHS compliant ('Green'). Consult factory for die / wafer form part numbers. Refer to Die Specification VF25 for layout and dimensions.

### **Absolute Maximum Ratings**

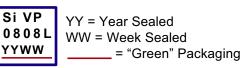
Parameter	Value
Drain-to-source voltage	BV <sub>DSS</sub>
Drain-to-gate voltage	BV <sub>DGS</sub>
Gate-to-source voltage	±30V
Operating and storage temperature	-55°C to +150°C

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied. Continuous operation of the device at the absolute rating level may affect device reliability. All voltages are referenced to device ground.





#### **Product Marking**



Package may or may not include the following marks: Si or 🎲

TO-92 (L)

## **Thermal Characteristics**

Package	I <sub>D</sub> (continuous) <sup>†</sup> (mA)	I <sub>D</sub> (pulsed) (A)	Power Dissipation @T <sub>c</sub> = 25°C (W)	<b>θ</b> <sub>jc</sub> (°C/W)	<b>θ</b> <sub>ja</sub> (°C/W)	I <sub>DR</sub> <sup>†</sup> (mA)	l <sub>DRM</sub> (mA)
TO-92	-280	-3.0	1.0	125	170	-280	-3.0

Notes:

*†*  $I_{D}$  (continuous) is limited by max rated  $T_{i}$ .

#### Electrical Characteristics (T<sub>A</sub> = 25°C unless otherwise specified)

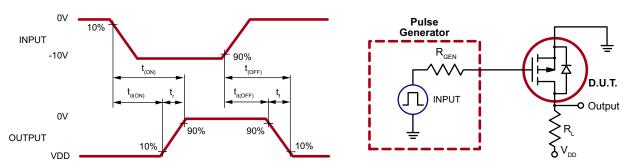
Sym	Parameter	Min	Тур	Max	Units	Conditions	
BV <sub>DSS</sub>	Drain-to-source breakdown voltage	-80	-	-	V	V <sub>GS</sub> = 0V, Ι <sub>D</sub> = -10μΑ	
V <sub>GS(th)</sub>	Gate threshold voltage	-1.0	-	-4.5	V	$V_{GS} = V_{DS}, I_{D} = -1.0 \text{mA}$	
I <sub>GSS</sub>	Gate body leakage current	-	-	-100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
	Zero gate voltage drain current		-	-10		$V_{GS}$ = 0V, $V_{DS}$ = Max Rating	
I <sub>DSS</sub>			-	-500	μA	$V_{DS}$ = 0.8 Max Rating, $V_{GS}$ = 0V, $T_{A}$ = 125°C	
I <sub>D(ON)</sub>	On-state drain current	-1.1	-	-	А	V <sub>GS</sub> = -10V, V <sub>DS</sub> = -15V	
R <sub>DS(ON)</sub>	Static drain-to-source on-state resistance	-	-	5.0	Ω	V <sub>GS</sub> = -10V, I <sub>D</sub> = -1.0A	
G <sub>FS</sub>	Forward transconductance	200	-	-	mmho	V <sub>DS</sub> = -10V, I <sub>D</sub> = -500mA	
C <sub>ISS</sub>	Input capacitance	-	-	150		$V_{GS} = 0V,$ $V_{DS} = -25V,$	
C <sub>oss</sub>	Common source output capacitance	-	-	60	pF		
C <sub>RSS</sub>	Reverse transfer capacitance	-	-	25		f = 1.0MHz	
t <sub>d(ON)</sub>	Turn-on time	-	-	15		$V_{DD} = -25V,$	
t,	Rise time	-	-	40	20		
t <sub>d(OFF)</sub>	Turn-off time		-	30	ns	$I_{D} = -500 \text{mA},$ $R_{GEN} = 25\Omega$	
t <sub>r</sub>	Fall time	-	-	30		GEN	
V <sub>SD</sub>	Diode forward voltage drop		-1.2	-	V	V <sub>GS</sub> = 0V, I <sub>SD</sub> = -900mA	

Notes:

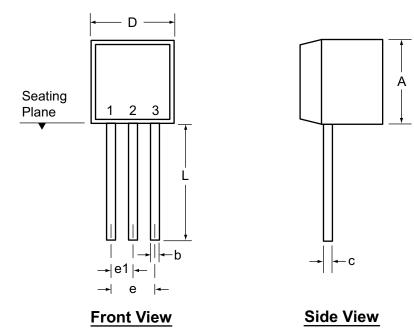
1. All D.C. parameters 100% tested at 25°C unless otherwise stated. (Pulse test: 300µs pulse, 2% duty cycle.)

2. All A.C. parameters sample tested.

## **Switching Waveforms and Test Circuit**



# 3-Lead TO-92 Package Outline (L)



Bottom View

Symb	ol	A	b	С	D	E	E1	е	e1	L
	MIN	.170	.014†	.014†	.175	.125	.080	.095	.045	.500
Dimensions (inches)	NOM	-	-	-	-	-	-	-	-	-
(mones)	MAX	.210	.022†	.022†	.205	.165	.105	.105	.055	.610*

JEDEC Registration TO-92.

\* This dimension is not specified in the JEDEC drawing.

† This dimension differs from the JEDEC drawing.

Drawings not to scale.

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(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to <u>http://www.supertex.com/packaging.html</u>.)

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